

CPU replaces optical module



Overview

CPO packages silicon photonics devices with ASICs, and is about to replace traditional pluggable optical modules, improving energy efficiency by 3.5 times and deployment speed by 1. Optical modules have historically provided high-speed data transmission between servers, switches, and GPU nodes. Quantum-X and Spectrum-X switches reduce dependence on traditional optical. NVIDIA's co-packaged optics (CPO) switches with integrated silicon photonics are the world's most advanced networking solution for the era of agentic AI. Replacing pluggable transceivers with silicon photonics on the same package as the ASIC, NVIDIA CPO innovations provide 5x better power. Explosive AI infrastructure growth is bringing high bandwidth density and low power performance requirements to compute architectures which optical connectivity is well positioned to support.

Article Content

Why do new computing chips not require optical modules?

As compute chips evolve in AI, HPC, and edge computing, a new generation of processors is emerging that reduces or eliminates the need for traditional optical modules.

Why Marvell Could Be a Key Player in CPO, Not Just Optical Module

CPO is often viewed as the next iteration of pluggable optical modules, leading many to assume optical module vendors will be the biggest beneficiaries. But Marvell's chip and system

Intel® Shows OCI Optical I/O Chiplet Co-packaged with CPU at

A co-packaged xPU (CPU, GPU, IPU) optical I/O solution can support higher bandwidths with high power efficiency, low latency, and longer reach, which is exactly what AI/ML infrastructure

CPO will soon replace pluggable optical modules, and Rubin will

CPO packages silicon photonics devices with ASICs, and is about to replace traditional pluggable optical modules, improving energy efficiency by 3.5 times and deployment speed by 1.3 times compared to

Silicon Photonics Networking for Agentic AI | NVIDIA

NVIDIA co-packaged optics with silicon photonics deliver 5x power efficiency and 10x resiliency, enabling scalable, high-performance networking for agentic AI.

Intel shows OCI optical I/O chiplet co-packaged with CPU at OFC2024 ...

At OFC2024 in San Diego, Intel demonstrated its advanced Optical Compute Interconnect (OCI) chiplet co-packaged with a prototype of a next-generation Intel CPU running an

Intel Demonstrates First Fully Integrated Optical I/O Chiplet

Intel Corporation's Integrated Photonics Solutions (IPS) Group has demonstrated the industry's first fully integrated optical compute interconnect (OCI) chiplet co-packaged with an Intel

Intel CPU with Optical Compute Interconnect Chiplet ...

Intel showed off a pretty cool piece of technology integrating an optical I/O chiplet with a CPU. The first iteration of the design is a fully integrated chiplet.

Integrated Photonics | Transitioning to End-to-End Optical I/O

Integrated photonics brings together the advantages of silicon photonics and CMOS circuits. By integrating the power of optical directly with compute, memory, and peripheral technologies, high

Co-Packaged Optics Gain Traction in Data Centers

Conventionally, optical transceivers (modules detachable from the board) that convert electrical signals to optical signals were placed at the edge of the board, away from the processor.

Mitsubishi Q172DSCPU Universal Q Series Motion Controller CPU Module

Sourcing a genuine Q13UDEHCPU or Q172DSCPU Mitsubishi Universal Q Series motion CPU featuring fiber-optic SSCNET interfaces to replace a non-responsive controller or scale up a synchronized

Powering AI: The Semiconductor Ecosystem at the Foundation of

Each compute board serves as a high-density processing module within the compute tray. It typically combines one or more high-performance AI Accelerators with a general-purpose CPU, tightly

How NVIDIA GB200 Utilizes 800G/1.6T DAC/ACC

Short-Range Reliability: Within a single GB200 NVL72 cabinet, copper cables replace optical modules for internal connections, reducing latency and simplifying infrastructure for distances

The Rise of Co-Packaged Optics: A Deep Dive into CPO Optical Modules

A CPO optical module integrates optical and electronic components to boost data center speed, efficiency, and bandwidth while reducing power use.

Why don't CPU's have a direct optical bus?

In the realm of computing, central processing units (CPUs) are the backbone of modern technology, executing instructions and processing data at lightning speeds. A notable observation in

The Rise of Co-Packaged Optics

In this scenario, Co-Packaged Optics (CPO) is now gaining momentum, emerging mainly as an alternative to the pluggable optical modules

What is Co-Packaged Optics (CPO) Technology? | Corning

Co-Packaged Optics (CPO) Solutions Co-Packaged Optics (CPO) Solutions Today, data centers use a separate approach for optics and electronics, in which optical modules are connected to switches

Scaling AI Factories with Co-Packaged Optics for Better Power ...

In contrast, switches with co-packaged optics (CPO) integrate the electro-optical conversion directly onto the switch package. Fiber connects directly with the optical engine that sits

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